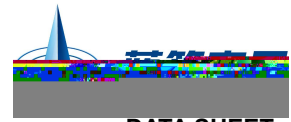


# BRCS200N10SZC

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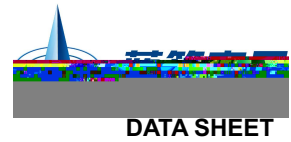
DATA SHEET

## / Revised record

A	2022.06.28	All	AOS-AON6452 BR-BRCS250N10SYB		

# BRCS200N10SZC

Rev.A Jun.-2022



## / Descriptions

代

PDFN 5×6 封装 N 沟道场效应管。

N-Channel MOSFET in a PDFN 5×6 Plastic Package .

## / Features

$V_{DS} (V) = 100V$

$I_D = 28A (V_{GS} = \pm 20V)$

$R_{DS(ON)} @ 10V \leq 20mR (Typ. 18mR)$

。 HF Product.

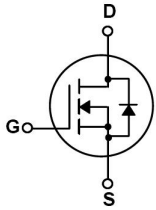
## / Applications

DC/DC AC/DC

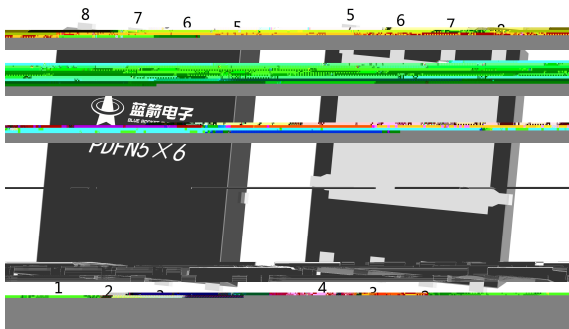
DC/DC

Synchronous rectification in DC/DC and AC/DC converters, Isolated DC/DC Converters in Telecom and Industrial.

## / Equivalent Circuit



## / Pinning

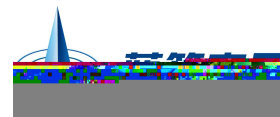


PIN1、2、3: S    PIN4: G    PIN5、6、7、8: D

Pin	极性
1	S
2	S
3	S
4	G
5	D
6	D
7	D
8	D

## / Marking

。 See Marking Instructions.

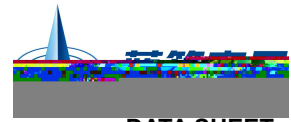


**/ Absolute Maximum Ratings(Ta=25 )**

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		$V_{DS}$	100	V
Drain Current		$I_D(T_C=25^\circ\text{C})$	28	A
Drain Current - Pulsed		$I_{DM}$	60	A
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Single Pulsed Avalanche Energy		$E_{AS}$	14.4	mJ
Avalanche Current		$I_{AS}$	6	A
Power Dissipation		$P_D(T_C=25^\circ\text{C})$	35	W
Operating and Storage Temperature Range		$T_J, T_{stg}$	-55 to 150	$^\circ\text{C}$
Junction-to-Ambient	$t \leq 10$	$R_{JA}$	30	$^\circ\text{C/W}$
Junction-to-Ambient	Steady-State		64	
Junction-to-Case	Steady-State	$R_{JC}$	3.5	

# BRCS200N10SZC

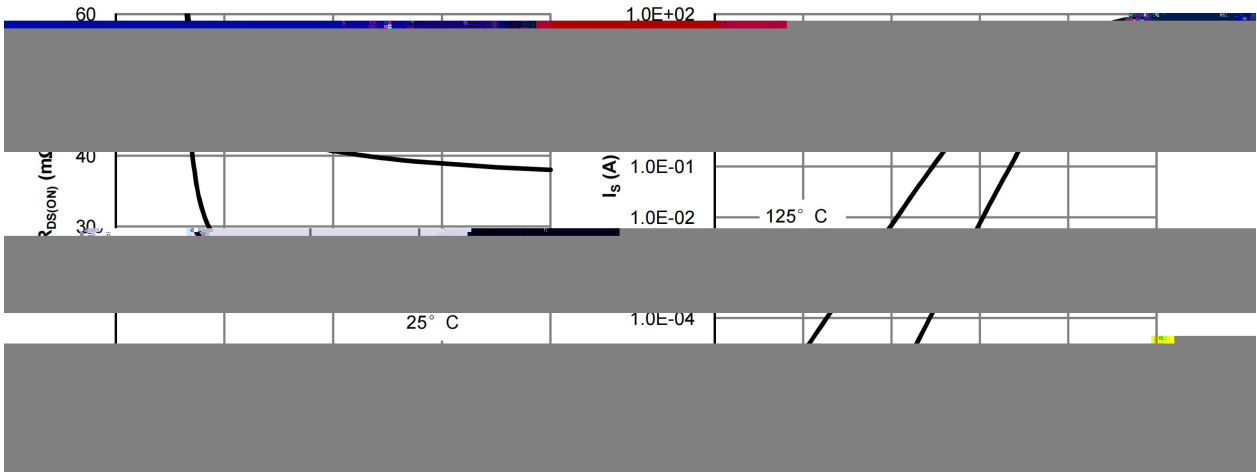
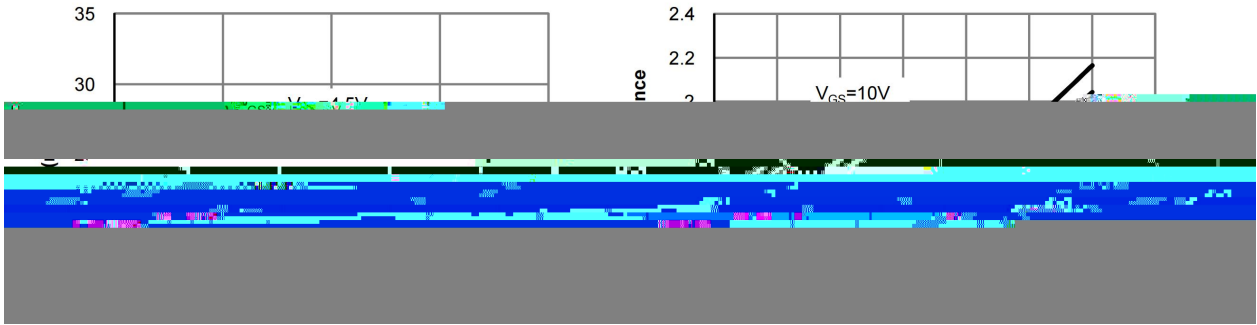
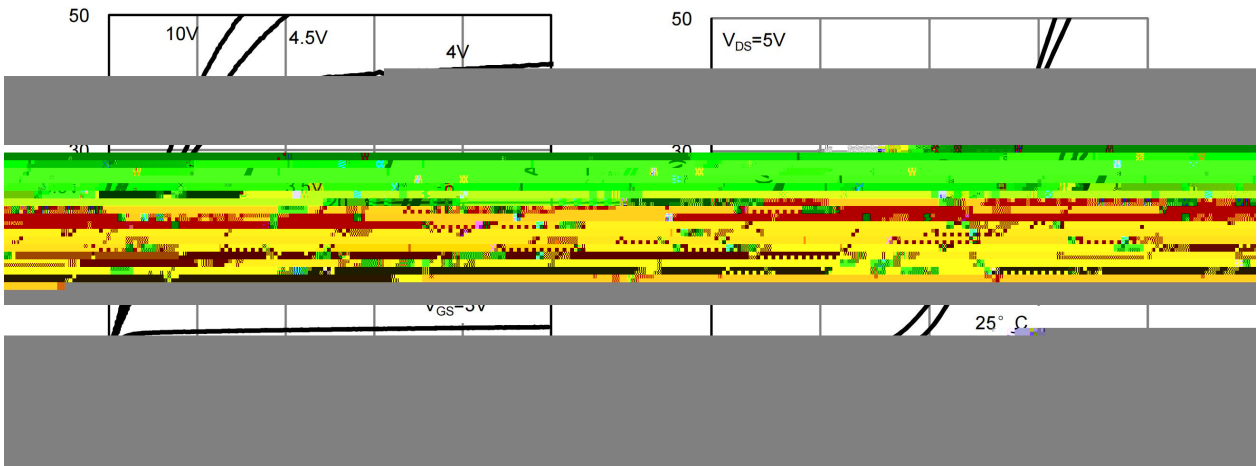
Rev.A Jun.-2022



DATA SHEET

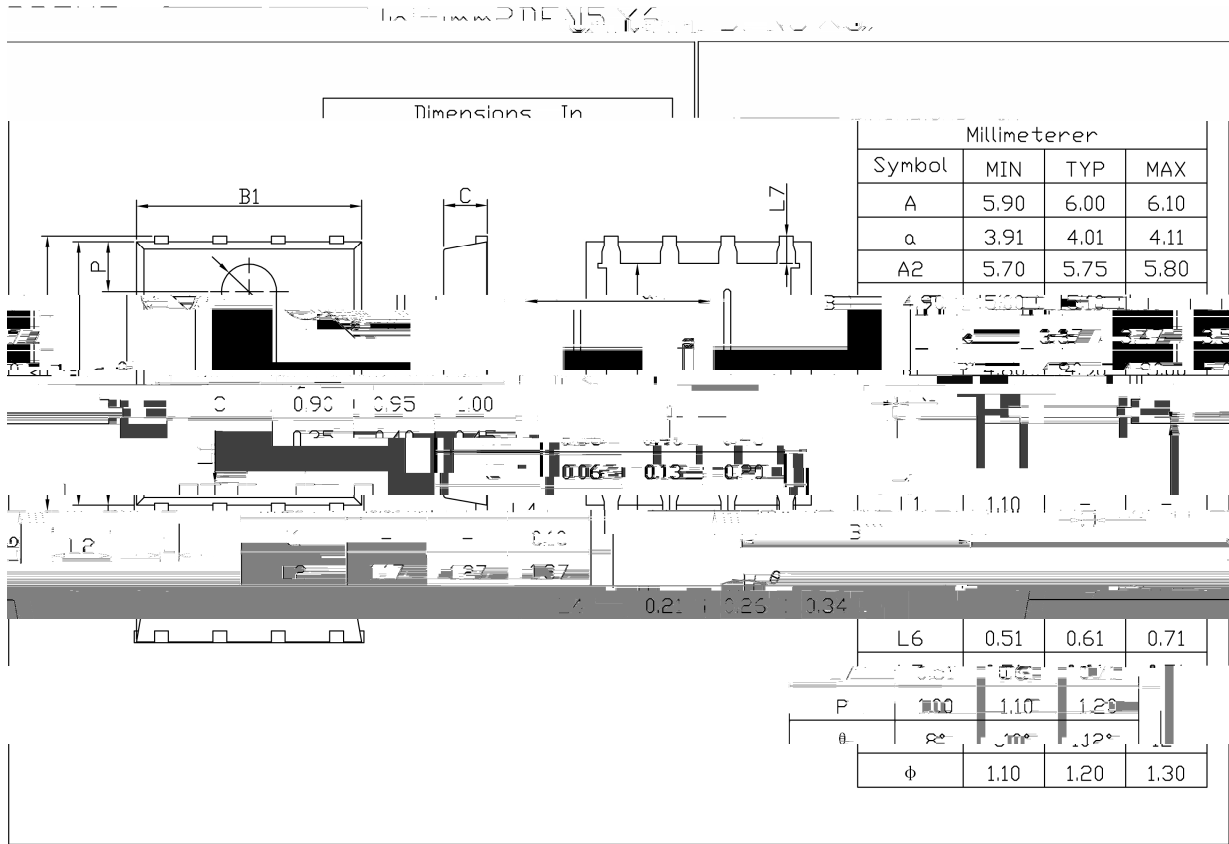
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V$ $I_D=250\mu A$	100	109		V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=100V$ $V_{GS}=0V$			1	$\mu A$
Gate-Body Leakage Current Forward	$I_{GSS}$	$V_{GS}=\pm 20V$ $V_{DS}=0V$			$\pm 0.1$	$\mu A$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ $I_D=250\mu A$	1.0	1.6	2.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V$ $I_D=20A$		18	20	m
		$V_{GS}=4.5V$ $I_D=10A$		25	28	m
Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V$ $I_S=1A$			1.2	V
Input Capacitance	$C_{iss}$	$V_{DS}=25V$ $V_{GS}=0V$ $f=1.0MHz$		820		pF
Output Capacitance	$C_{oss}$			475		
Reverse Transfer Capacitance	$C_{rss}$			35		
Gate resistance	$R_g$	$V_{GS}=0V$ $V_{DS}=0V$ $f=1MHz$		1.9		
Total Gate Charge	$Q_{g(10V)}$	$V_{GS}=10V$ $V_{DS}=50V$ $I_D=9A$		17		nC
Total Gate Charge	$Q_{g(4.5V)}$			9		
Gate Source Charge	$Q_{gs}$			3		
Gate Drain Charge	$Q_{gd}$			3.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=10V$ $V_{DS}=50V$ $R_L=5.5$ $R_{GEN}=3.0$		5		ns
Turn-On Rise Time	$t_r$			3.2		
Turn-Off Delay Time	$t_{d(off)}$			21		
Turn-Off Fall Time	$t_f$			3		

/ Electrical Characteristic Curve

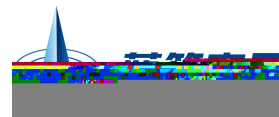




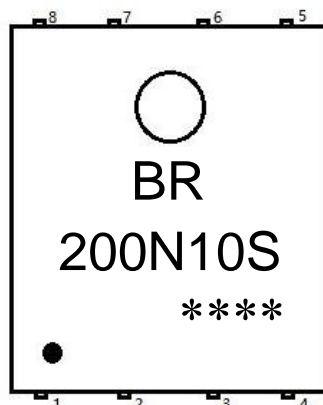
**/ / Package Dimensions 外能**



Rev.00 201812



## / Marking Instructions



说明：

BR： 为公司代码

200N10S： 为产品型号

\*\*\*\*： 为生产批号代码，随生产批号变化

Note：

BR： Company Code

200N10S： Product Type

\*\*\*\*： Lot No. Code, code change with Lot No



**( ) / 耐回流焊温度无油曲线**


- |   |         |           |       |  |
|---|---------|-----------|-------|--|
| 1 | 150 180 | 60 90sec; | Note: | 1.Preheating:150~180°C, Time:60~90sec.   |
| 2 | 245±5   | 5±0.5sec; |       | 2.Peak Temp.:245±5°C, Duration:5±0.5sec. |
| 3 | 2       | 10°C/sec. |       | 3. Cooling Speed: 2~10°C/sec.            |

**/ Resistance to Soldering Heat Test**